



US00D824876S

(12) **United States Design Patent**
Wei et al.

(10) **Patent No.: US D824,876 S**

(45) **Date of Patent: ** Aug. 7, 2018**

(54) **EARPHONE COMPONENT**

D767,532 S * 9/2016 Jen D14/205
D774,490 S * 12/2016 Lin D14/205
D776,083 S * 1/2017 Lee D14/205

(Continued)

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Beijing (CN)

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(**) Term: **15 Years**

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(30) **Foreign Application Priority Data**

Dec. 23, 2015 (CN) 2015 3 0551360

(51) **LOC (11) Cl.** **14-01**

(52) **U.S. Cl.**

USPC **D14/205**; D14/206

(58) **Field of Classification Search**

USPC D14/205–206; D29/112

CPC H04R 1/1066; H04R 1/1016; H04R 25/00;

H04R 1/10; H04R 5/0335; H04R 5/033

See application file for complete search history.

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D741,287 S * 10/2015 Harata D14/205

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Bose-QuietComfort20(QC20) headphones, exact date unknown,
dated at least as early as in Oct. 2013.

(Continued)

Primary Examiner — Michael A. Pratt

(74) *Attorney, Agent, or Firm* — Margaret Polson; Polson
Intellectual Property Law, PC

(57) **CLAIM**

The ornamental design for an earphone component, as
shown and described.

DESCRIPTION

Figure 1.1 is a perspective view of one earphone component.

Figure 1.2 is a front side elevation view of Figure 1.1

Figure 1.3 is a back side elevation view of Figure 1.1

Figure 1.4 is a left side elevation view of Figure 1.1

Figure 1.5 is a right side elevation view of Figure 1.1

Figure 1.6 is a top side plan view of Figure 1.1

Figure 1.7 is a bottom side plan view of Figure 1.1

Figure 1.8 is a reference view of the earphone component as
configured for use.

Figure 4.1 is a front side elevation view of one earphone
component

Figure 4.2 is a back side elevation view of Figure 4.1

Figure 4.3 is left side elevation view of Figure 4.1

Figure 4.4 is a right side elevation view of Figure 4.1

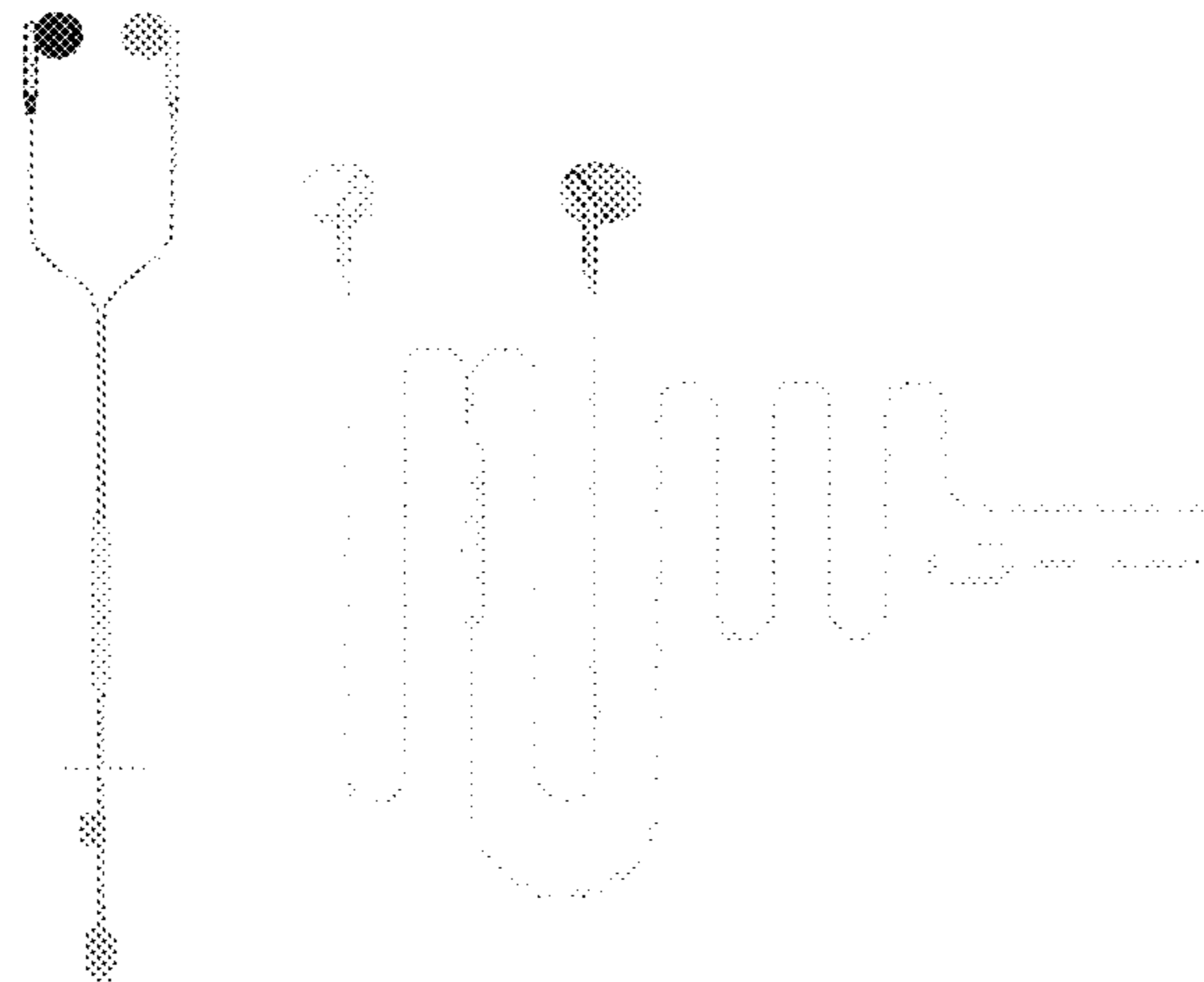
Figure 4.5 is a top side plan view of Figure 4.1

Figure 4.6 a bottom view of Figure 4.1.

Figure 4.7 is perspective view of Figure 4.1.

Figure 4.8 is a reference view of the earphone component as
configured for use.

(Continued)



The faded areas in Figures 1.8, 1.9 and 4.8 are reference views thereof and show environmental matter showing the designs in use, and form no part of the claimed designs.

1 Claim, 17 Drawing Sheets

(56) **References Cited**

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B&O(Bang & Olufsen)—BeoPlay H3 headphones, exact date unknown, dated at least as early as in Jul. 2013.

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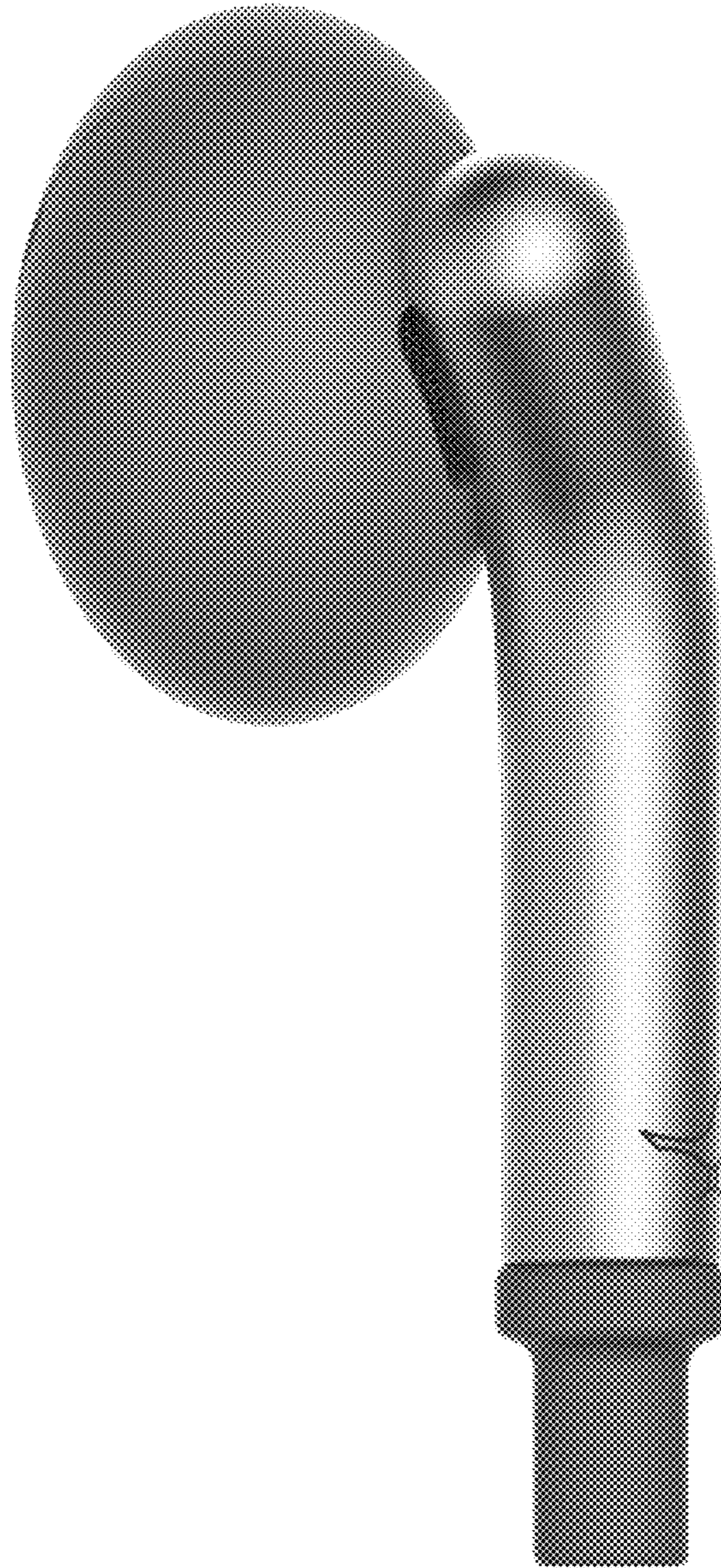
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1.2



1.3



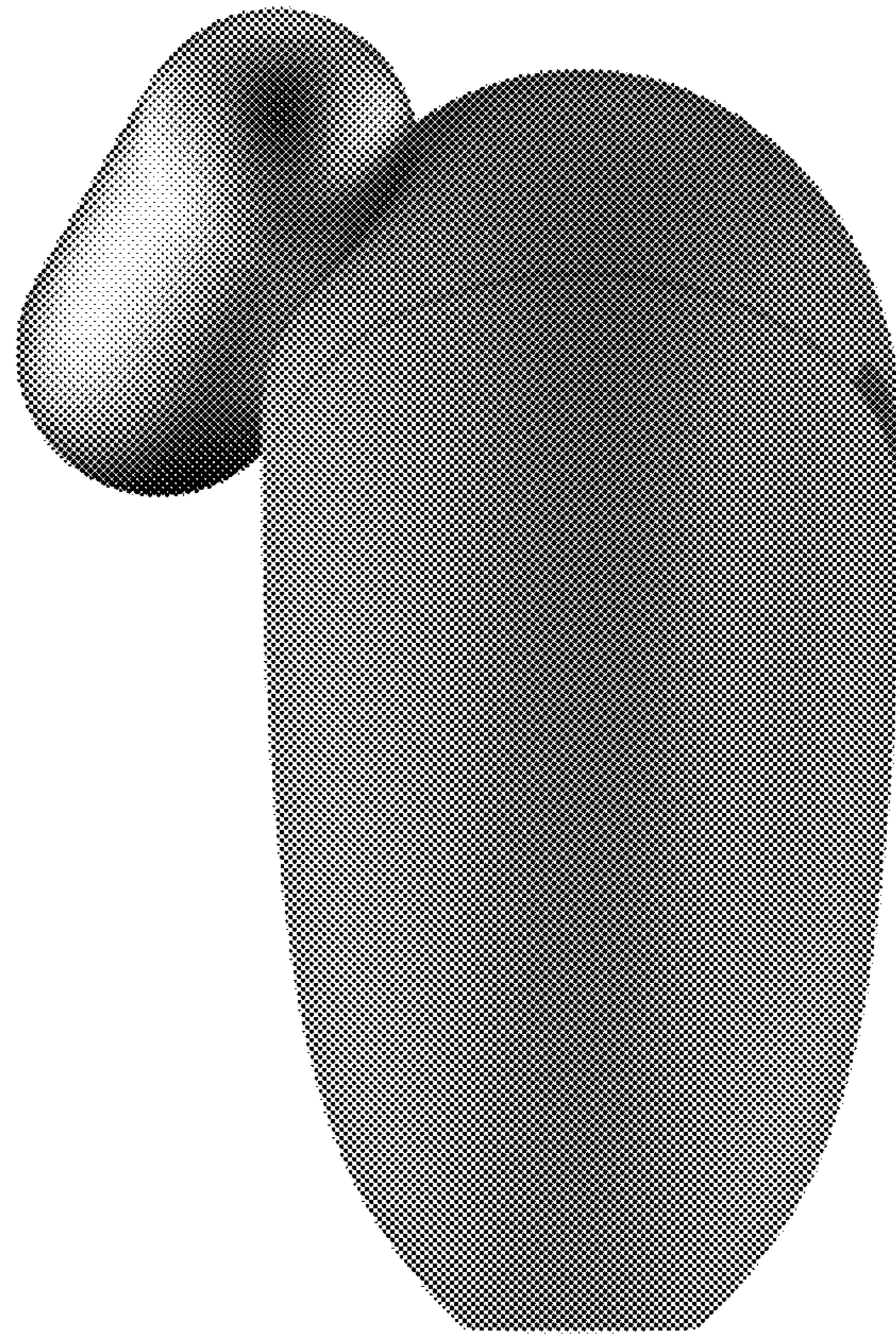
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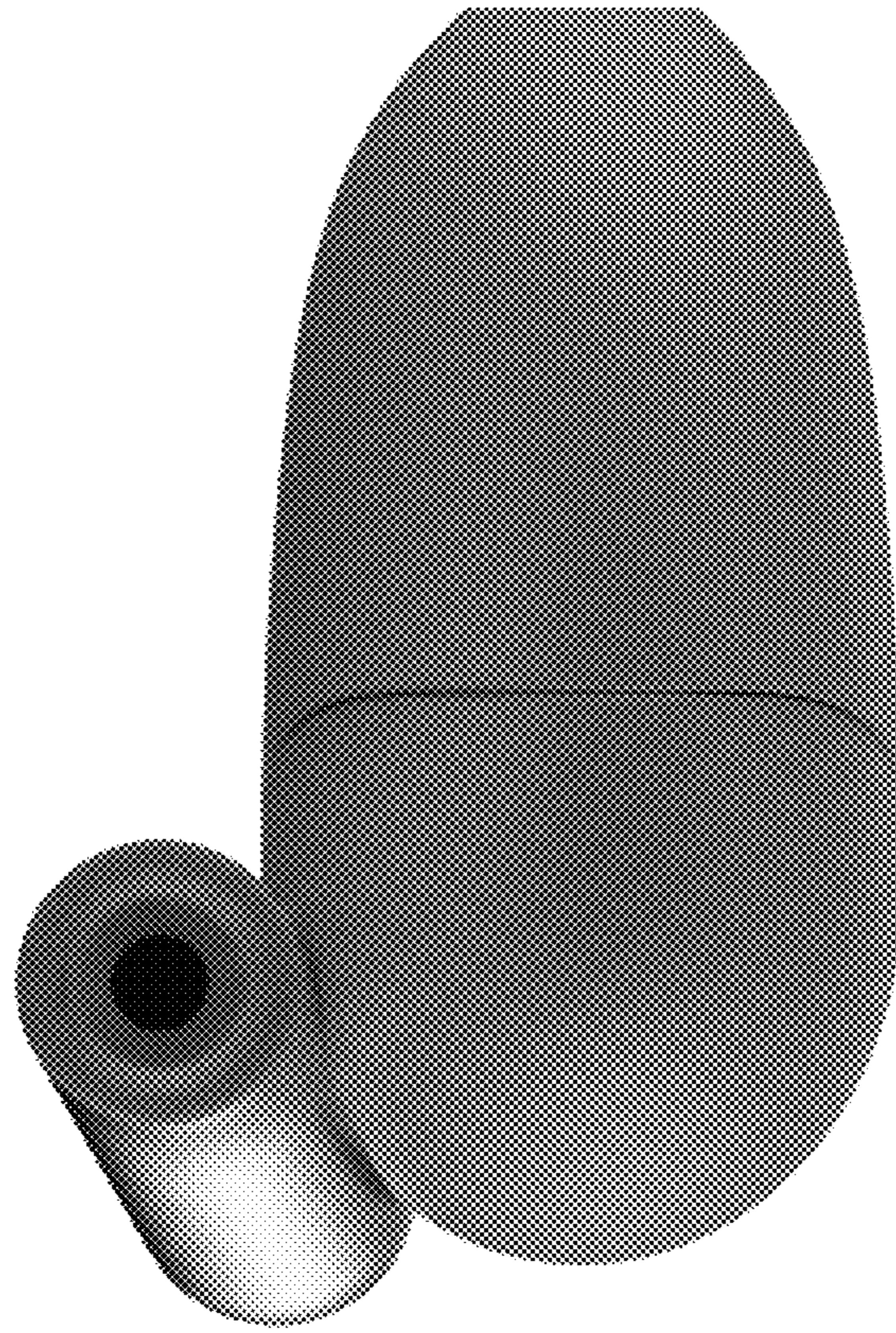
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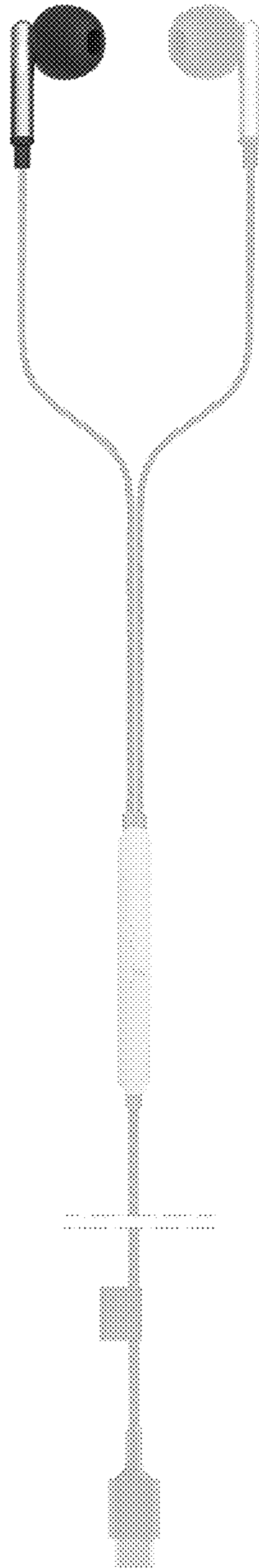
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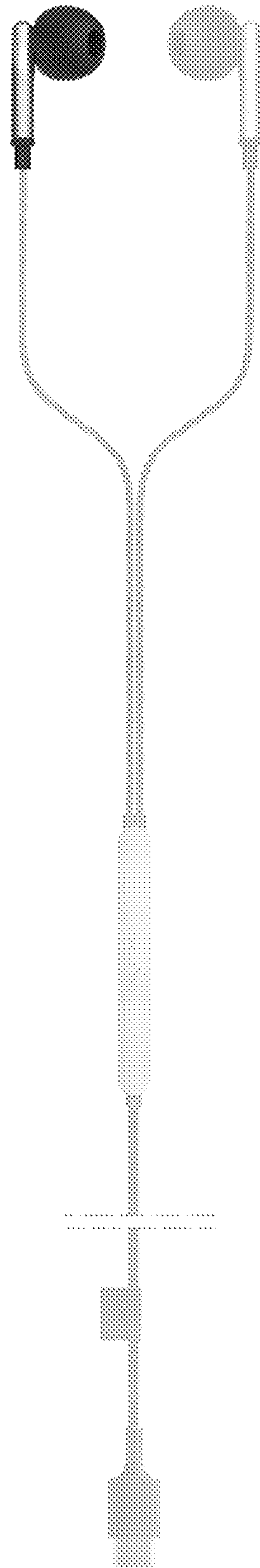
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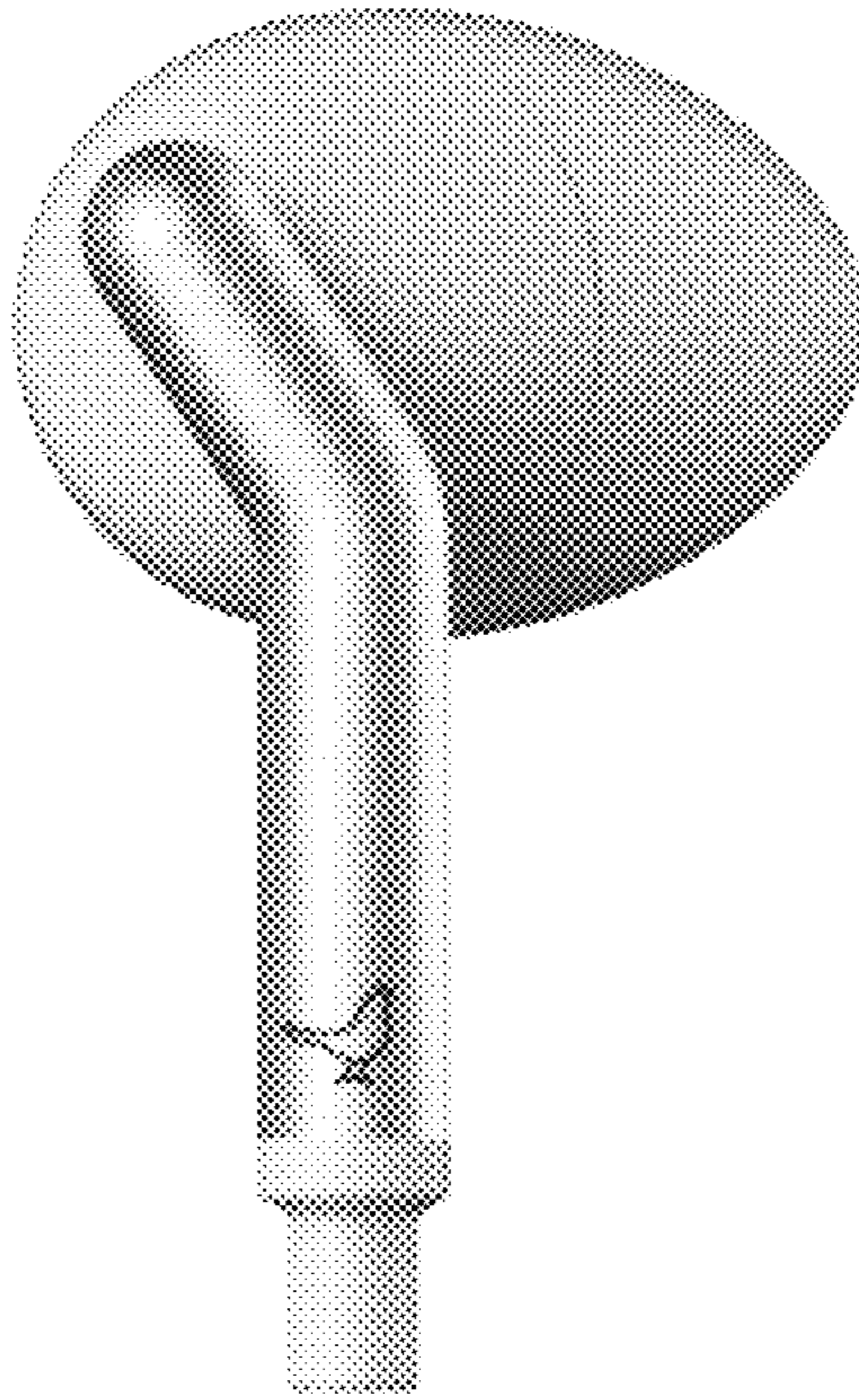
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1.9



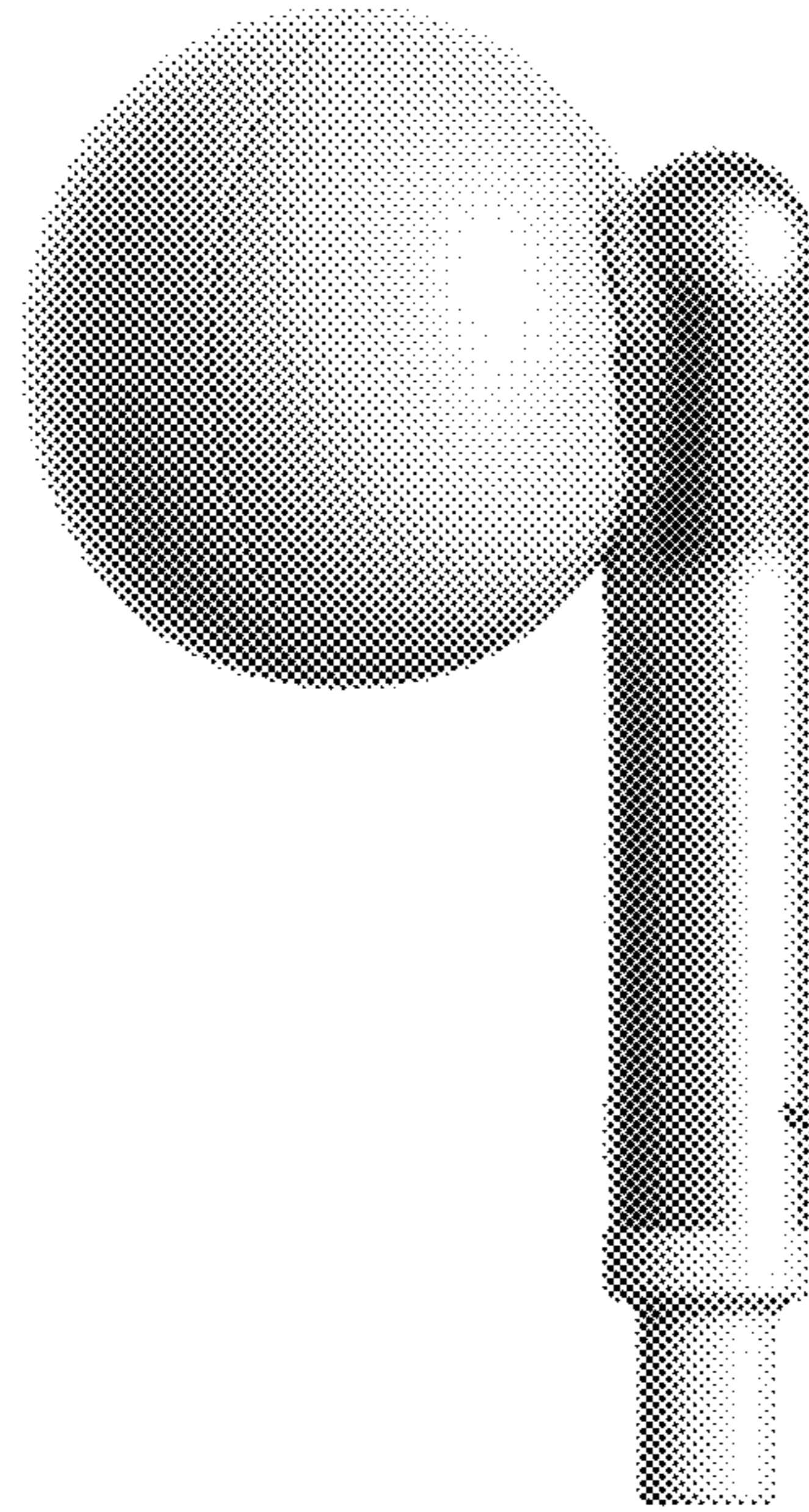
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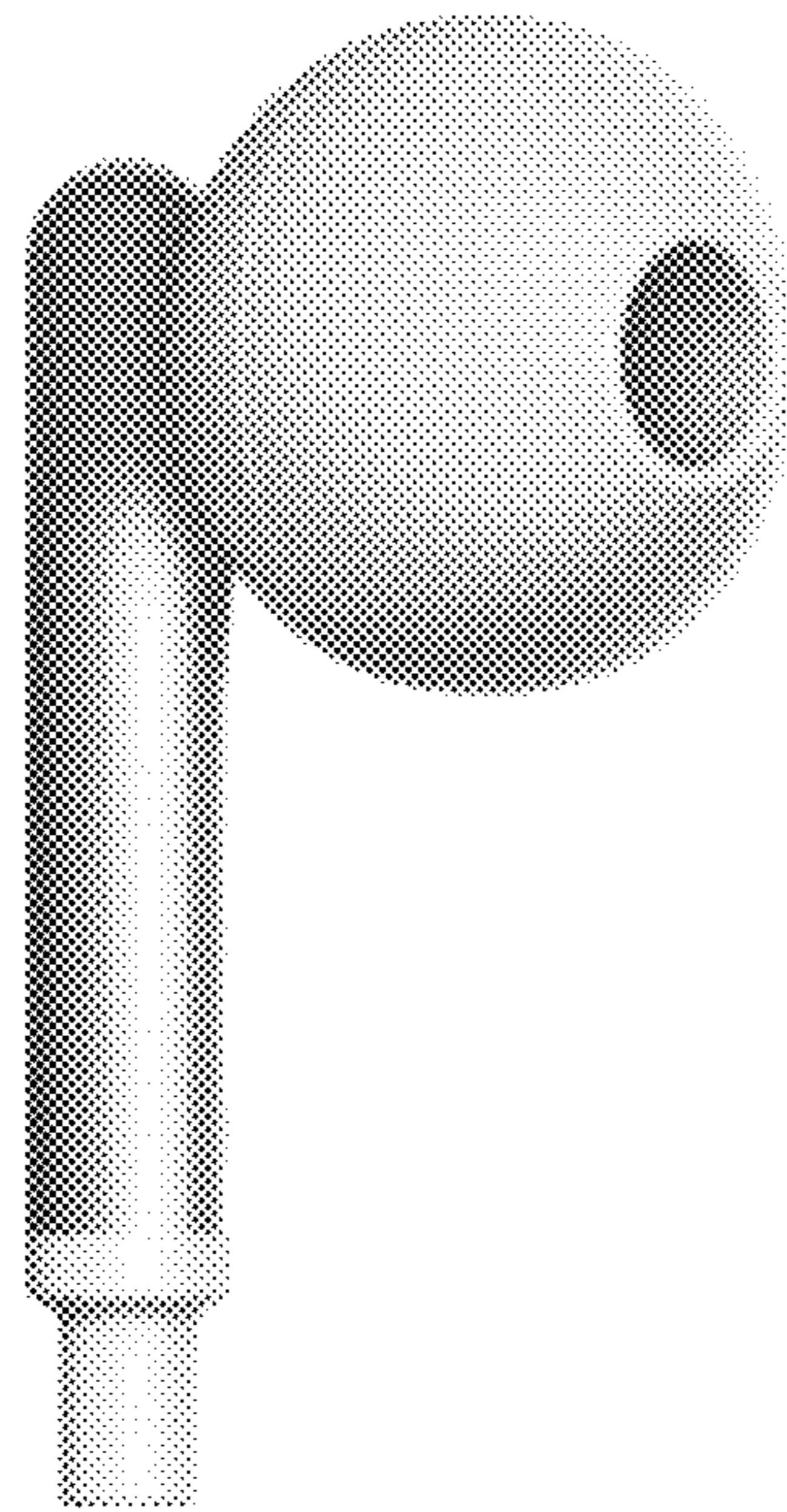
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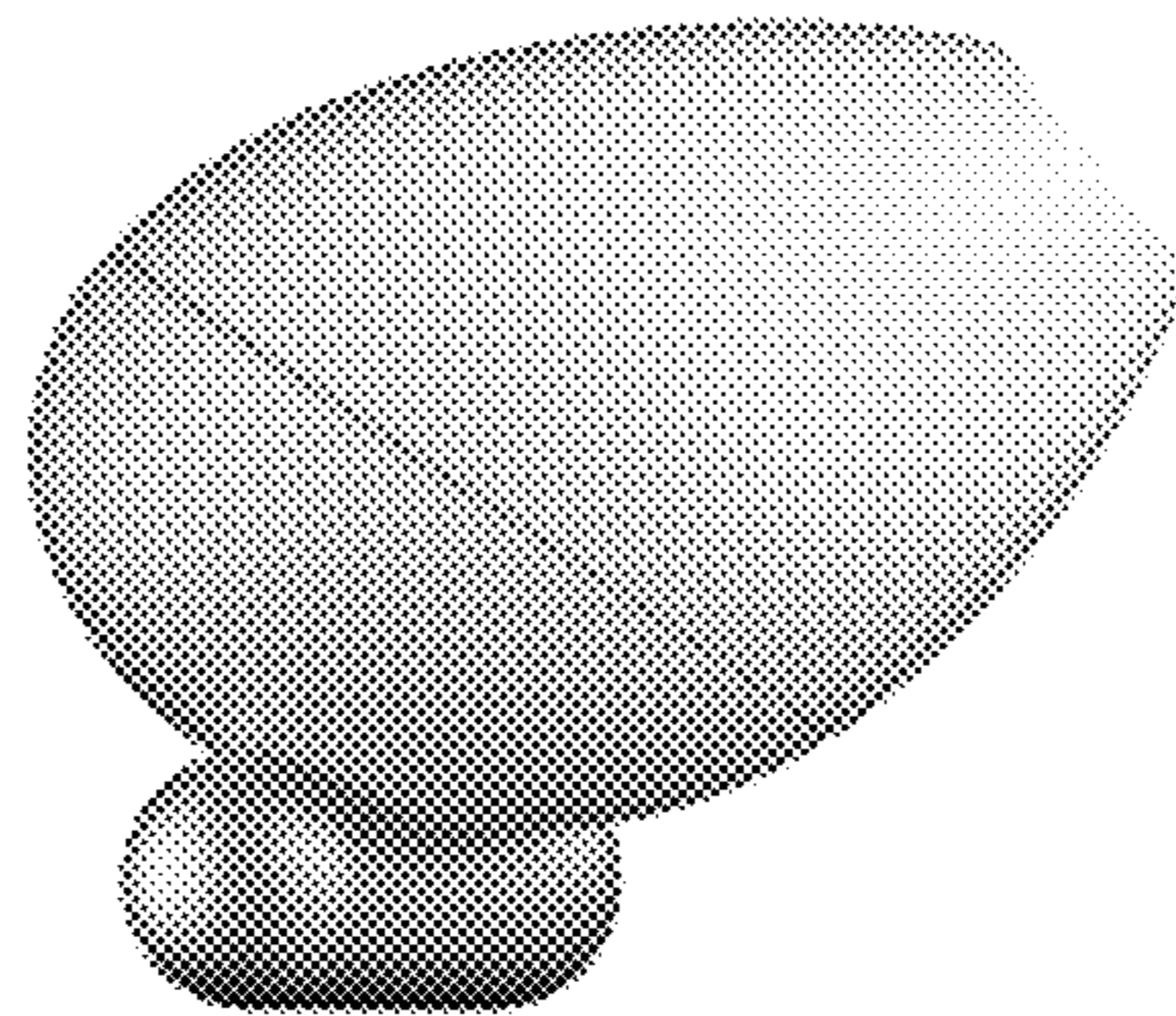
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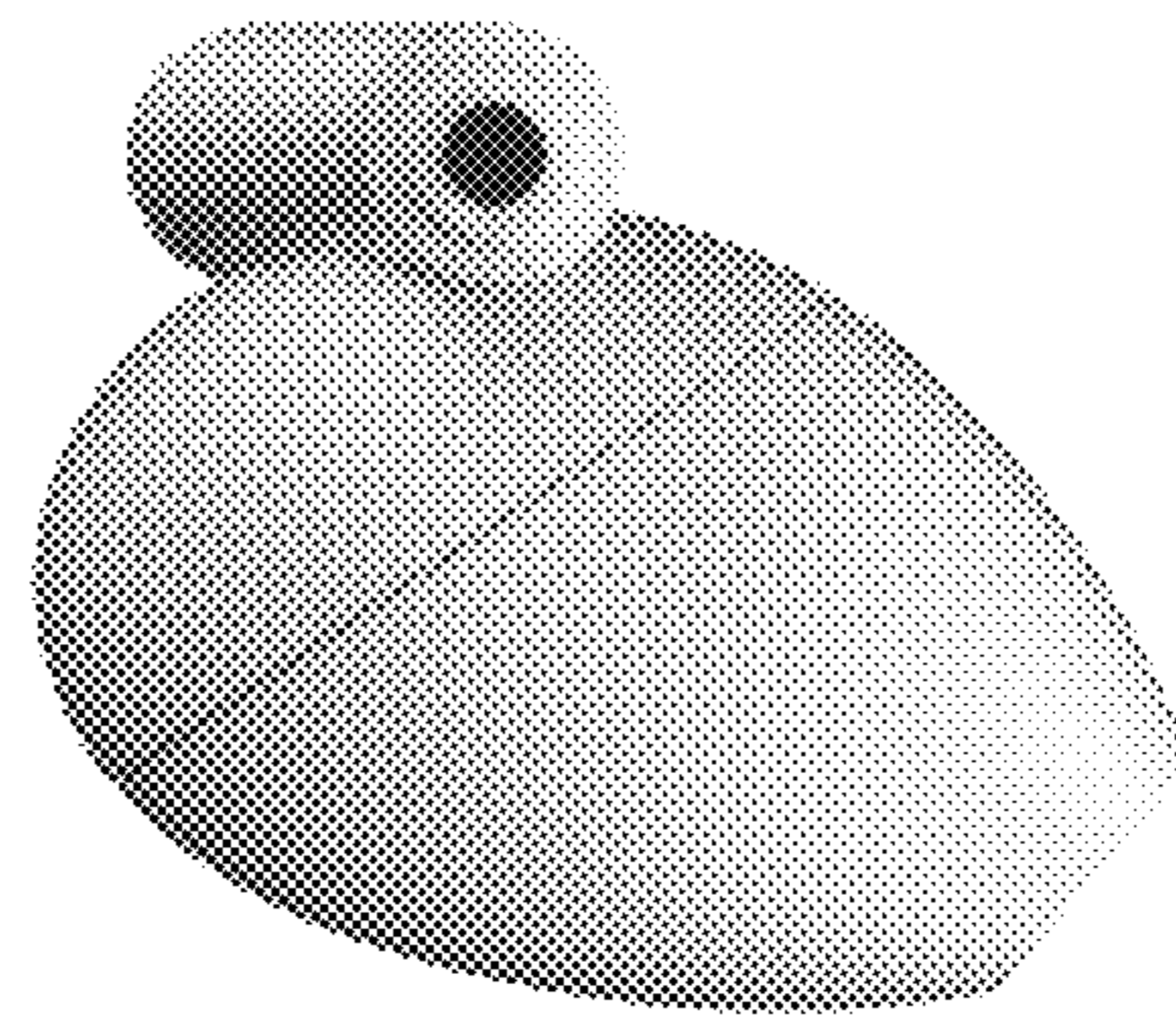
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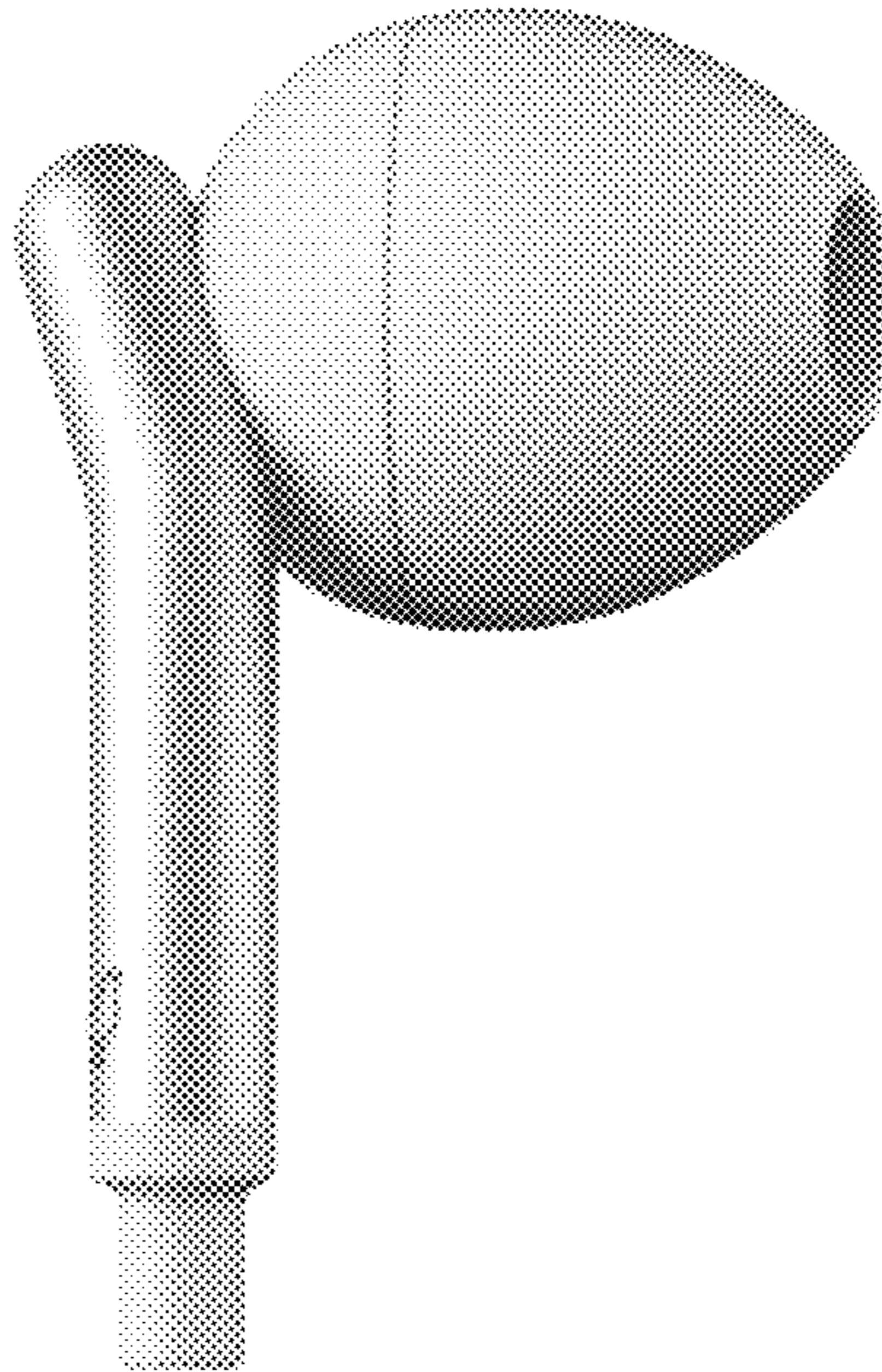
4.5



4.6



4.7



4.8

